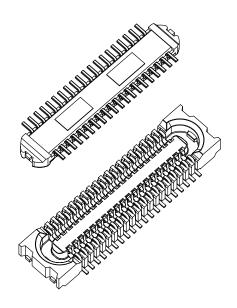


KGN CONNECTOR

0.35 mm pitch/For PC Board/Board-to-Board connection



This connector is 0.35 mm pitch board-to-board (FPC) connection connector with mounting height 1.0 mm, product width 2.88 mm.

Features

- Contact lock mechanism for secure high retention force
- 2-point contact provides high reliability
- · Secure wiring space at the bottom of the contact (No pattern prohibited area)
- Applicable for 0.5 A / pin
- Clear click feeling when mating

■ Specifications

- Current rating: 0.5 A AC/DCVoltage rating: 30 V AC/DC
- · Temperature range: -25°C to +85°C

(including temperature rise in applying

electrical current)

• Contact resistance: Initial value/50 m Ω max.

After environmental tests/ $80 \text{ m}\Omega$ max.

• Insulation resistance : 10 M Ω min.

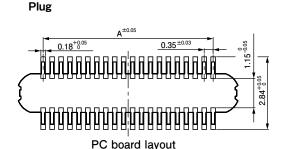
· Withstanding voltage: There shall be no breakdown or

flashover while applying 100 VAC

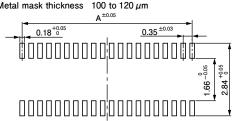
for one minute.

- * In using the products, refer to "Handling Precaution for Terminares and Connectors" described on our website (Technical documents of Product information page).
- * RoHS2 compliance
- * Dimensional unit: mm
- * Contact JST for details.

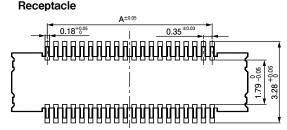
PC board lavout



• Metal mask thickness 100 to 120 μm

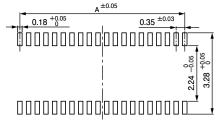


Metal mask layout



PC board layout

• Metal mask thickness 100 to 120 μ m



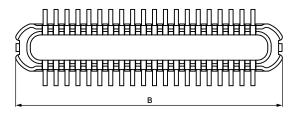
Metal mask layout

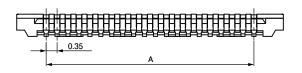
- Note: 1. PC board layout is the figure viewed from the connector mounting side.

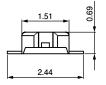
 2. Tolerances for the PCB pattern pitch shall be ± 0.03 and shall not accumulate.

 Please contact JST for details as the dimensions shown in the above figure are reference values.
 - 3. Contact JST for nitrogen (N2) reflow soldering.

Plug



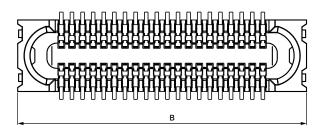




No. of circuits	Model No.	Dimensions (mm)		Q'ty/reel	Material and Finish
		Α	В	Q ty/1661	
40	40P - JKGNK - GAN - ETF(HF)	6.65	8.53	9,000	Contact: Copper alloy, nickel-undercoated, gold-plated Housing: LCP, UL94V-0 Other: Brass
60	60P-JKGNK-GAN-ETF(HF)	10.15	12.03	9,000	
90	90P-JKGNK-GAN-ETF(HF)	15.4	17.28	9,000	

Note: The products listed above are supplied on embossed-tape.

Receptacle





No. of circuits		Dimensions (mm)		Q'tv/reel	Material and Finish
		Α	В	Q ty/1001	
40	40R1.0 - JKGNK - GAN - ETF (HF)	6.65	9.53	7,400	Contact: Copper alloy, nickel-undercoated, gold-plated Housing: LCP, UL94V-0 Other: Brass
60	60R1.0 - JKGNK - GAN - ETF (HF)	10.15	13.03	7,400	
90	90R1.0 - JKGNK - GAN - ETF (HF)	15.4	18.28	7,400	

Note: The products listed above are supplied on embossed-tape.